

# IS62WV12816ALL IS62WV12816BLL



## 128K x 16 LOW VOLTAGE, ULTRA LOW POWER CMOS STATIC RAM

NOVEMBER 2013

### FEATURES

- High-speed access time: 45ns, 55ns, 70ns
- CMOS low power operation
  - 36 mW (typical) operating
  - 9  $\mu$ W (typical) CMOS standby
- TTL compatible interface levels
- Single power supply
  - 1.65V--2.2V  $V_{DD}$  (62WV12816ALL)
  - 2.5V--3.6V  $V_{DD}$  (62WV12816BLL)
- Fully static operation: no clock or refresh required
- Three state outputs
- Data control for upper and lower bytes
- Industrial temperature available
- 2CS Option Available
- Lead-free available

### DESCRIPTION

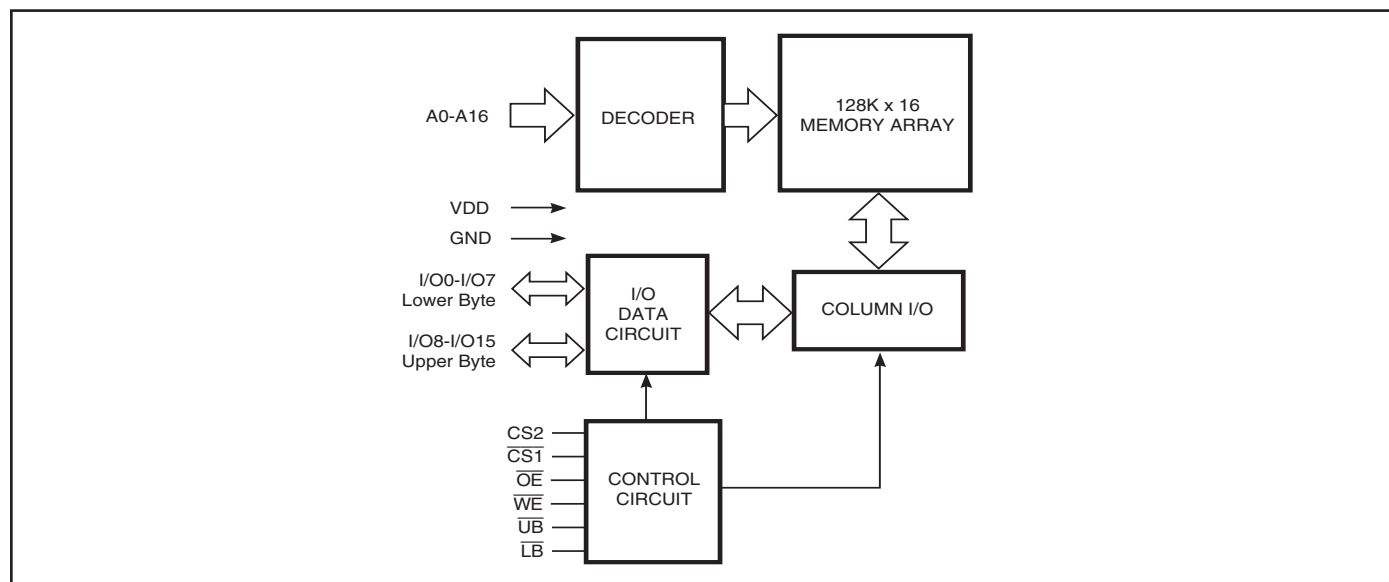
The *ISSI* IS62WV12816ALL/IS62WV12816BLL are high-speed, 2M bit static RAMs organized as 128K words by 16 bits. It is fabricated using *ISSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields high-performance and low power consumption devices.

When  $\overline{CS1}$  is HIGH (deselected) or when  $\overline{CS2}$  is LOW (deselected) or when  $\overline{CS1}$  is LOW,  $\overline{CS2}$  is HIGH and both  $\overline{LB}$  and  $\overline{UB}$  are HIGH, the device assumes a standby mode at which the power dissipation can be reduced down with CMOS input levels.

Easy memory expansion is provided by using Chip Enable and Output Enable inputs. The active LOW Write Enable ( $\overline{WE}$ ) controls both writing and reading of the memory. A data byte allows Upper Byte ( $\overline{UB}$ ) and Lower Byte ( $\overline{LB}$ ) access.

The IS62WV12816ALL and IS62WV12816BLL are packaged in the JEDEC standard 48-pin mini BGA (6mm x 8mm) and 44-Pin TSOP (TYPE II).

### FUNCTIONAL BLOCK DIAGRAM

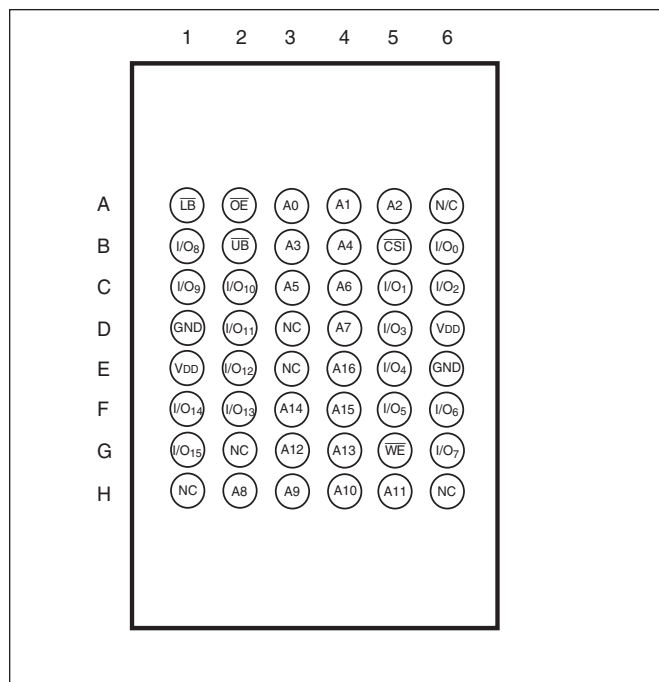
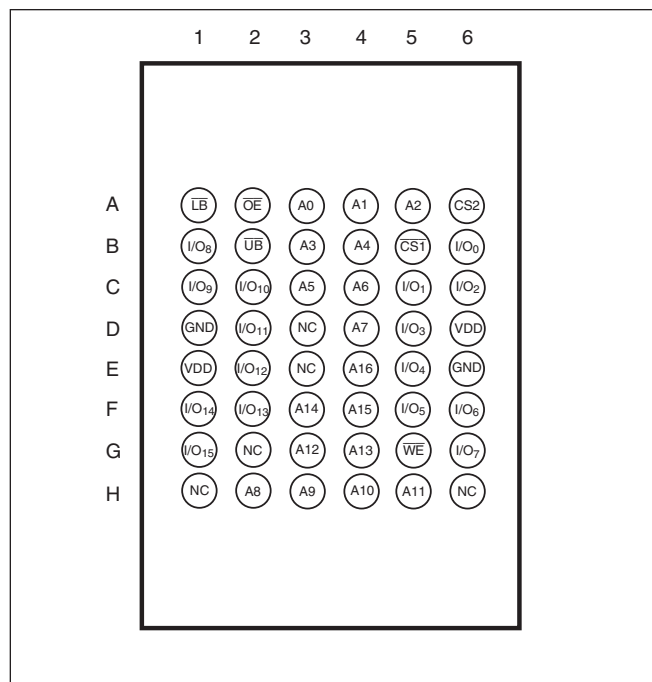
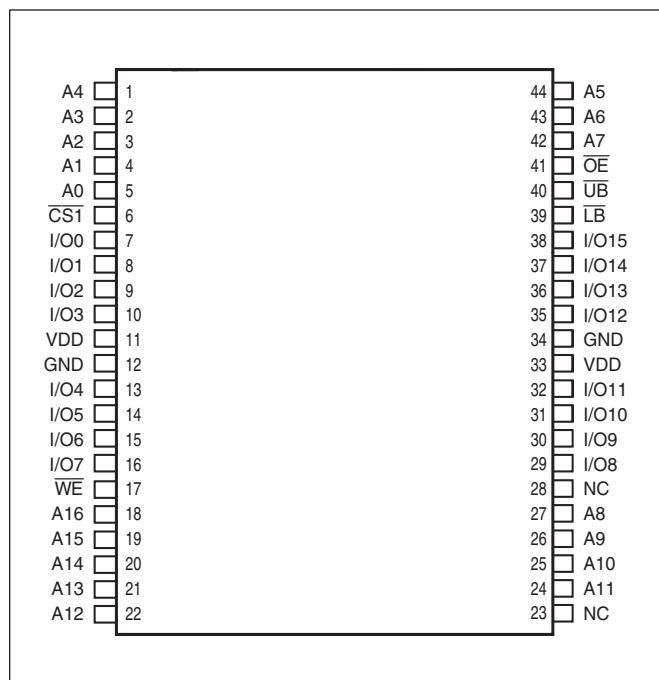


Copyright © 2013 Integrated Silicon Solution, Inc. All rights reserved. ISSI reserves the right to make changes to this specification and its products at any time without notice. ISSI assumes no liability arising out of the application or use of any information, products or services described herein. Customers are advised to obtain the latest version of this device specification before relying on any published information and before placing orders for products.

Integrated Silicon Solution, Inc. does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless Integrated Silicon Solution, Inc. receives written assurance to its satisfaction, that:

- a.) the risk of injury or damage has been minimized;
- b.) the user assume all such risks; and
- c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances

## PIN CONFIGURATIONS

48-Pin mini BGA (6mm x 8mm)  
(Package Code B)48-Pin mini BGA (6mm x 8mm)  
2 CS Option (Package Code B2)44-Pin mini TSOP (Type II)  
(Package Code T)

## PIN DESCRIPTIONS

|            |                                 |
|------------|---------------------------------|
| A0-A16     | Address Inputs                  |
| I/O0-I/O15 | Data Inputs/Outputs             |
| CS1, CS2   | Chip Enable Input               |
| OE         | Output Enable Input             |
| WE         | Write Enable Input              |
| LB         | Lower-byte Control (I/O0-I/O7)  |
| UB         | Upper-byte Control (I/O8-I/O15) |
| NC         | No Connection                   |
| VDD        | Power                           |
| GND        | Ground                          |

## TRUTH TABLE

| Mode            | $\overline{WE}$ | $\overline{CS1}$ | CS2 | $\overline{OE}$ | $\overline{LB}$ | $\overline{UB}$ | I/O PIN   |            | V <sub>DD</sub> Current             |
|-----------------|-----------------|------------------|-----|-----------------|-----------------|-----------------|-----------|------------|-------------------------------------|
|                 |                 |                  |     |                 |                 |                 | I/O0-I/O7 | I/O8-I/O15 |                                     |
| Not Selected    | X               | H                | X   | X               | X               | X               | High-Z    | High-Z     | I <sub>SB1</sub> , I <sub>SB2</sub> |
|                 | X               | X                | L   | X               | X               | X               | High-Z    | High-Z     | I <sub>SB1</sub> , I <sub>SB2</sub> |
|                 | X               | X                | X   | X               | H               | H               | High-Z    | High-Z     | I <sub>SB1</sub> , I <sub>SB2</sub> |
| Output Disabled | H               | L                | H   | H               | L               | X               | High-Z    | High-Z     | I <sub>CC</sub>                     |
|                 | H               | L                | H   | H               | X               | L               | High-Z    | High-Z     | I <sub>CC</sub>                     |
| Read            | H               | L                | H   | L               | L               | H               | DOUT      | High-Z     | I <sub>CC</sub>                     |
|                 | H               | L                | H   | L               | H               | L               | High-Z    | DOUT       |                                     |
|                 | H               | L                | H   | L               | L               | L               | DOUT      | DOUT       |                                     |
| Write           | L               | L                | H   | X               | L               | H               | DIN       | High-Z     | I <sub>CC</sub>                     |
|                 | L               | L                | H   | X               | H               | L               | High-Z    | DIN        |                                     |
|                 | L               | L                | H   | X               | L               | L               | DIN       | DIN        |                                     |

ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol            | Parameter                            | Value                        | Unit |
|-------------------|--------------------------------------|------------------------------|------|
| V <sub>TERM</sub> | Terminal Voltage with Respect to GND | -0.2 to V <sub>DD</sub> +0.3 | V    |
| T <sub>STG</sub>  | Storage Temperature                  | -65 to +150                  | °C   |
| P <sub>T</sub>    | Power Dissipation                    | 1.0                          | W    |

## Note:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE (V<sub>DD</sub>)

| Range      | Ambient Temperature | IS62WV12816ALL | IS62WV12816BLL |
|------------|---------------------|----------------|----------------|
| Commercial | 0°C to +70°C        | 1.65V - 2.2V   | 2.5V - 3.6V    |
| Industrial | -40°C to +85°C      | 1.65V - 2.2V   | 2.5V - 3.6V    |

**DC ELECTRICAL CHARACTERISTICS** (Over Operating Range)

| Symbol                         | Parameter           | Test Conditions                                             | V <sub>DD</sub> | Min. | Max.                  | Unit |
|--------------------------------|---------------------|-------------------------------------------------------------|-----------------|------|-----------------------|------|
| V <sub>OH</sub>                | Output HIGH Voltage | I <sub>OH</sub> = -0.1 mA                                   | 1.65-2.2V       | 1.4  | —                     | V    |
|                                |                     | I <sub>OH</sub> = -1 mA                                     | 2.5-3.6V        | 2.2  | —                     | V    |
| V <sub>OL</sub>                | Output LOW Voltage  | I <sub>OL</sub> = 0.1 mA                                    | 1.65-2.2V       | —    | 0.2                   | V    |
|                                |                     | I <sub>OL</sub> = 2.1 mA                                    | 2.5-3.6V        | —    | 0.4                   | V    |
| V <sub>IH</sub>                | Input HIGH Voltage  |                                                             | 1.65-2.2V       | 1.4  | V <sub>DD</sub> + 0.2 | V    |
|                                |                     |                                                             | 2.5-3.6V        | 2.2  | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub> <sup>(1)</sup> | Input LOW Voltage   |                                                             | 1.65-2.2V       | -0.2 | 0.4                   | V    |
|                                |                     |                                                             | 2.5-3.6V        | -0.2 | 0.8                   | V    |
| I <sub>LI</sub>                | Input Leakage       | GND ≤ V <sub>IN</sub> ≤ V <sub>DD</sub>                     |                 | -1   | 1                     | μA   |
| I <sub>LO</sub>                | Output Leakage      | GND ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub> , Outputs Disabled |                 | -1   | 1                     | μA   |

**Notes:**

1. V<sub>IL</sub> (min.) = -1.0V for pulse width less than 10 ns.

**CAPACITANCE**<sup>(1)</sup>

| Symbol           | Parameter                | Conditions            | Max. | Unit |
|------------------|--------------------------|-----------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 0V  | 8    | pF   |
| C <sub>OUT</sub> | Input/Output Capacitance | V <sub>OUT</sub> = 0V | 10   | pF   |

**Note:**

1. Tested initially and after any design or process changes that may affect these parameters.

**IS62WV12816ALL, POWER SUPPLY CHARACTERISTICS<sup>(1)</sup>** (Over Operating Range)

| Symbol           | Parameter                                        | Test Conditions                                                                                                                                                                                   | Max.<br>70 | Unit |
|------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------|
| I <sub>CC</sub>  | V <sub>DD</sub> Dynamic Operating Supply Current | V <sub>DD</sub> = Max., Com.<br>I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub> Ind.                                                                                                                | 15<br>20   | mA   |
| I <sub>CC1</sub> | Operating Supply Current                         | V <sub>DD</sub> = Max., Com.<br>I <sub>OUT</sub> = 0 mA, f = 0 Ind.                                                                                                                               | 3<br>3     | mA   |
| I <sub>SB1</sub> | TTL Standby Current (TTL Inputs)                 | V <sub>DD</sub> = Max., Com.<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> Ind.<br>$\overline{CS1}$ = V <sub>IH</sub> , CS2 = V <sub>IL</sub> ,<br>f = 1 MHz <b>OR</b>                  | 0.3<br>0.3 | mA   |
|                  | ULB Control                                      | V <sub>DD</sub> = Max., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>$\overline{CS1}$ = V <sub>IL</sub> , f = 0, $\overline{UB}$ = V <sub>IH</sub> , $\overline{LB}$ = V <sub>IH</sub> |            |      |
| I <sub>SB2</sub> | CMOS Standby Current (CMOS Inputs)               | V <sub>DD</sub> = Max., Com.<br>$\overline{CS1}$ ≥ V <sub>DD</sub> - 0.2V, Ind.<br>CS2 ≤ 0.2V,<br>V <sub>IN</sub> ≥ V <sub>DD</sub> - 0.2V, or<br>V <sub>IN</sub> ≤ 0.2V, f = 0 <b>OR</b>         | 5<br>10    | μA   |
|                  | ULB Control                                      | V <sub>DD</sub> = Max., $\overline{CS1}$ = V <sub>IL</sub> , CS2 = V <sub>IH</sub><br>V <sub>IN</sub> ≤ 0.2V, f = 0; $\overline{UB}$ / $\overline{LB}$ = V <sub>DD</sub> - 0.2V                   |            |      |

**IS62WV12816BLL, POWER SUPPLY CHARACTERISTICS<sup>(1)</sup>** (Over Operating Range)

| Symbol           | Parameter                                        | Test Conditions                                                                                                                                                                                               | Max.<br>45     | Max.<br>55     | Unit |
|------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|----------------|------|
| I <sub>CC</sub>  | V <sub>DD</sub> Dynamic Operating Supply Current | V <sub>DD</sub> = Max., Com.<br>I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub> Ind.<br>typ. <sup>(2)</sup>                                                                                                     | 35<br>40<br>25 | 25<br>30<br>20 | mA   |
| I <sub>CC1</sub> | Operating Supply Current                         | V <sub>DD</sub> = Max., Com.<br>I <sub>OUT</sub> = 0 mA, f = 0 Ind.                                                                                                                                           | 3<br>3         | 3<br>3         | mA   |
| I <sub>SB1</sub> | TTL Standby Current (TTL Inputs)                 | V <sub>DD</sub> = Max., Com.<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> Ind.<br>$\overline{CS1}$ = V <sub>IH</sub> , CS2 = V <sub>IL</sub> ,<br>f = 1 MHz <b>OR</b>                              | 0.3<br>0.3     | 0.3<br>0.3     | mA   |
|                  | ULB Control                                      | V <sub>DD</sub> = Max., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>$\overline{CS1}$ = V <sub>IL</sub> , f = 0, $\overline{UB}$ = V <sub>IH</sub> , $\overline{LB}$ = V <sub>IH</sub>             |                |                |      |
| I <sub>SB2</sub> | CMOS Standby Current (CMOS Inputs)               | V <sub>DD</sub> = Max., Com.<br>$\overline{CS1}$ ≥ V <sub>DD</sub> - 0.2V, Ind.<br>CS2 ≤ 0.2V, typ. <sup>(2)</sup><br>V <sub>IN</sub> ≥ V <sub>DD</sub> - 0.2V, or<br>V <sub>IN</sub> ≤ 0.2V, f = 0 <b>OR</b> | 10<br>10<br>3  | 10<br>10<br>3  | μA   |
|                  | ULB Control                                      | V <sub>DD</sub> = Max., $\overline{CS1}$ = V <sub>IL</sub> , CS2 = V <sub>IH</sub><br>V <sub>IN</sub> ≤ 0.2V, f = 0; $\overline{UB}$ / $\overline{LB}$ = V <sub>DD</sub> - 0.2V                               |                |                |      |

**Note:**

- At f = f<sub>MAX</sub>, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.
- Typical values are measured at V<sub>DD</sub> = 3.0V, T<sub>A</sub> = 25°C and not 100% tested.

AC TEST CONDITIONS

| Parameter                                      | 62WV12816ALL<br>(Unit)        | 62WV12816BLL<br>(Unit)        |
|------------------------------------------------|-------------------------------|-------------------------------|
| Input Pulse Level                              | 0.4V to V <sub>DD</sub> -0.2V | 0.4V to V <sub>DD</sub> -0.3V |
| Input Rise and Fall Times                      | 5 ns                          | 5ns                           |
| Input and Output Timing<br>and Reference Level | V <sub>REF</sub>              | V <sub>REF</sub>              |
| Output Load                                    | See Figures 1 and 2           | See Figures 1 and 2           |

|                  | 1.65-2.2V | 2.5V - 3.6V |
|------------------|-----------|-------------|
| R1(Ω)            | 3070      | 3070        |
| R2(Ω)            | 3150      | 3150        |
| V <sub>REF</sub> | 0.9V      | 1.5V        |
| V <sub>TM</sub>  | 1.8V      | 2.8V        |

AC TEST LOADS

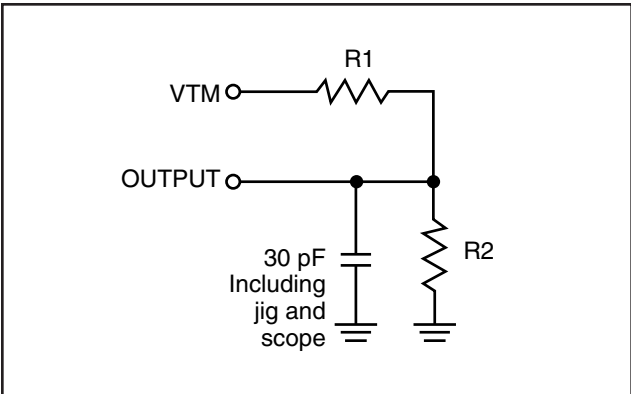


Figure 1

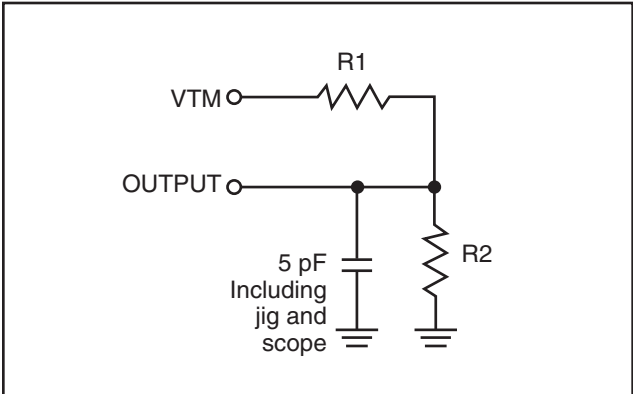


Figure 2

**READ CYCLE SWITCHING CHARACTERISTICS<sup>(1)</sup>** (Over Operating Range)

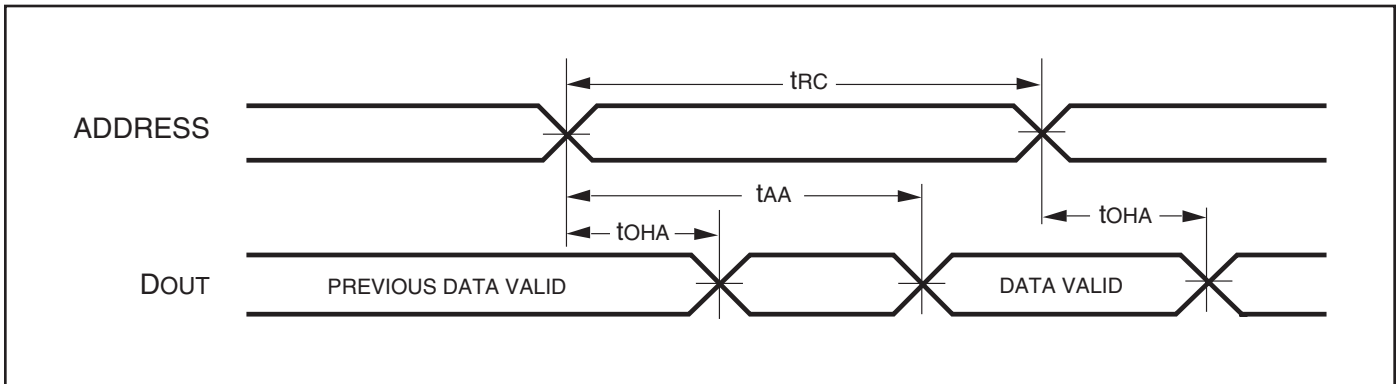
| Symbol                      | Parameter                                       | 45 ns |      | 55 ns |      | 70 ns |      | Unit |
|-----------------------------|-------------------------------------------------|-------|------|-------|------|-------|------|------|
|                             |                                                 | Min.  | Max. | Min.  | Max. | Min.  | Max. |      |
| $t_{RC}$                    | Read Cycle Time                                 | 45    | —    | 55    | —    | 70    | —    | ns   |
| $t_{AA}$                    | Address Access Time                             | —     | 45   | —     | 55   | —     | 70   | ns   |
| $t_{OHA}$                   | Output Hold Time                                | 10    | —    | 10    | —    | 10    | —    | ns   |
| $t_{ACS1}/t_{ACS2}$         | $\overline{CS1}/CS2$ Access Time                | —     | 45   | —     | 55   | —     | 70   | ns   |
| $t_{DOE}$                   | $\overline{OE}$ Access Time                     | —     | 20   | —     | 25   | —     | 35   | ns   |
| $t_{HZOE}^{(2)}$            | $\overline{OE}$ to High-Z Output                | —     | 15   | —     | 20   | —     | 25   | ns   |
| $t_{LZOE}^{(2)}$            | $\overline{OE}$ to Low-Z Output                 | 5     | —    | 5     | —    | 5     | —    | ns   |
| $t_{HZCS1}/t_{HZCS2}^{(2)}$ | $\overline{CS1}/CS2$ to High-Z Output           | 0     | 15   | 0     | 20   | 0     | 25   | ns   |
| $t_{LZCS1}/t_{LZCS2}^{(2)}$ | $\overline{CS1}/CS2$ to Low-Z Output            | 10    | —    | 10    | —    | 10    | —    | ns   |
| $t_{BA}$                    | $\overline{LB}, \overline{UB}$ Access Time      | —     | 45   | —     | 55   | —     | 70   | ns   |
| $t_{HQB}$                   | $\overline{LB}, \overline{UB}$ to High-Z Output | 0     | 15   | 0     | 20   | 0     | 25   | ns   |
| $t_{LQB}$                   | $\overline{LB}, \overline{UB}$ to Low-Z Output  | 0     | —    | 0     | —    | 0     | —    | ns   |

**Notes:**

1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 0.9V, input pulse levels of 0.4 to 1.4V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured  $\pm 500$  mV from steady-state voltage. Not 100% tested.

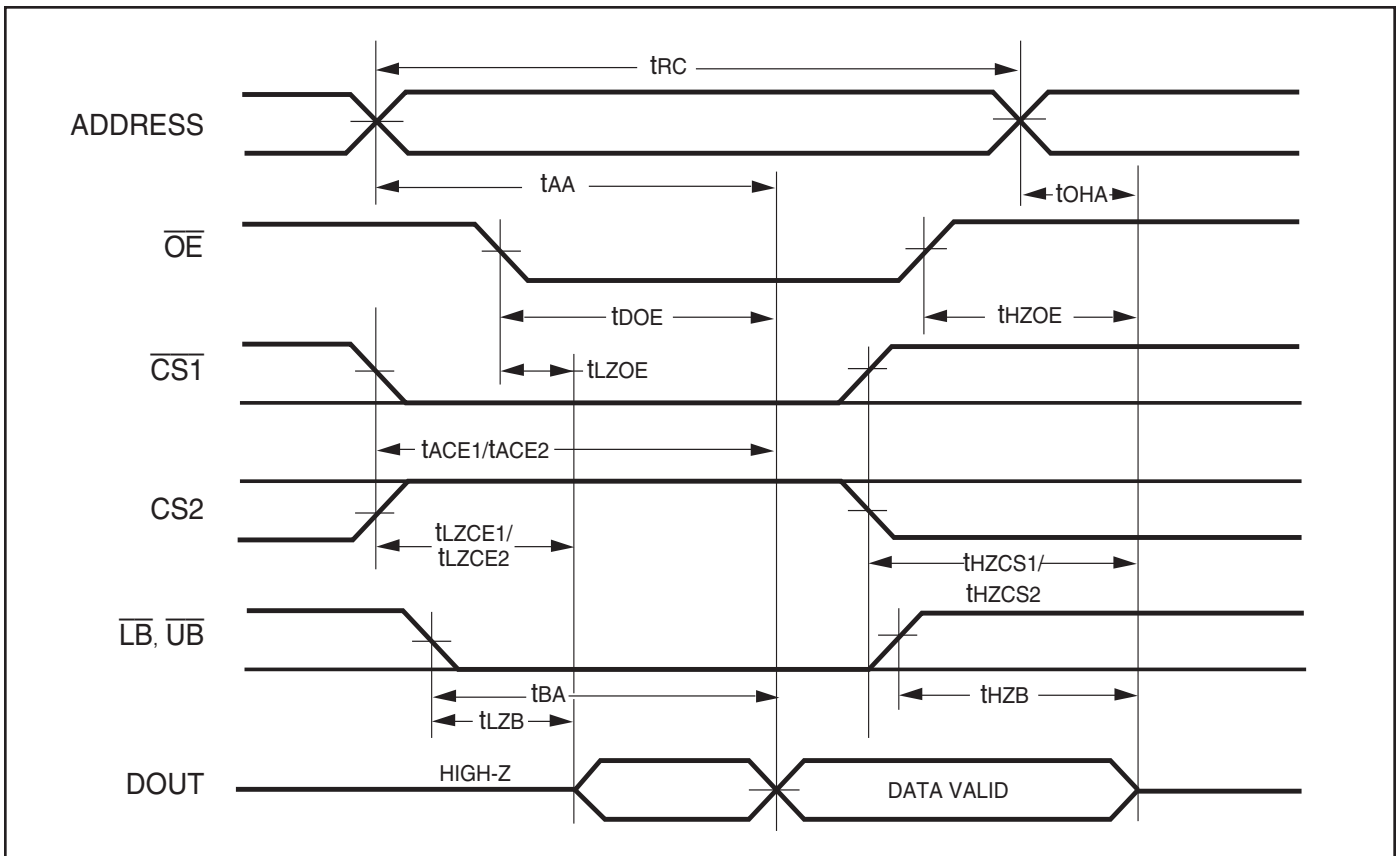
## AC WAVEFORMS

**READ CYCLE NO. 1<sup>(1,2)</sup>** (Address Controlled) ( $\overline{CS1} = \overline{OE} = V_{IL}$ ,  $CS2 = \overline{WE} = V_{IH}$ ,  $\overline{UB}$  or  $\overline{LB} = V_{IL}$ )



## AC WAVEFORMS

**READ CYCLE NO. 2<sup>(1,3)</sup>** ( $\overline{CS1}$ ,  $CS2$ ,  $\overline{OE}$ , AND  $\overline{UB}/\overline{LB}$  Controlled)

**Notes:**

1.  $\overline{WE}$  is HIGH for a Read Cycle.
2. The device is continuously selected.  $\overline{OE}$ ,  $\overline{CS1}$ ,  $\overline{UB}$ , or  $\overline{LB} = V_{IL}$ .  $CS2 = \overline{WE} = V_{IH}$ .
3. Address is valid prior to or coincident with  $\overline{CS1}$  LOW transition.

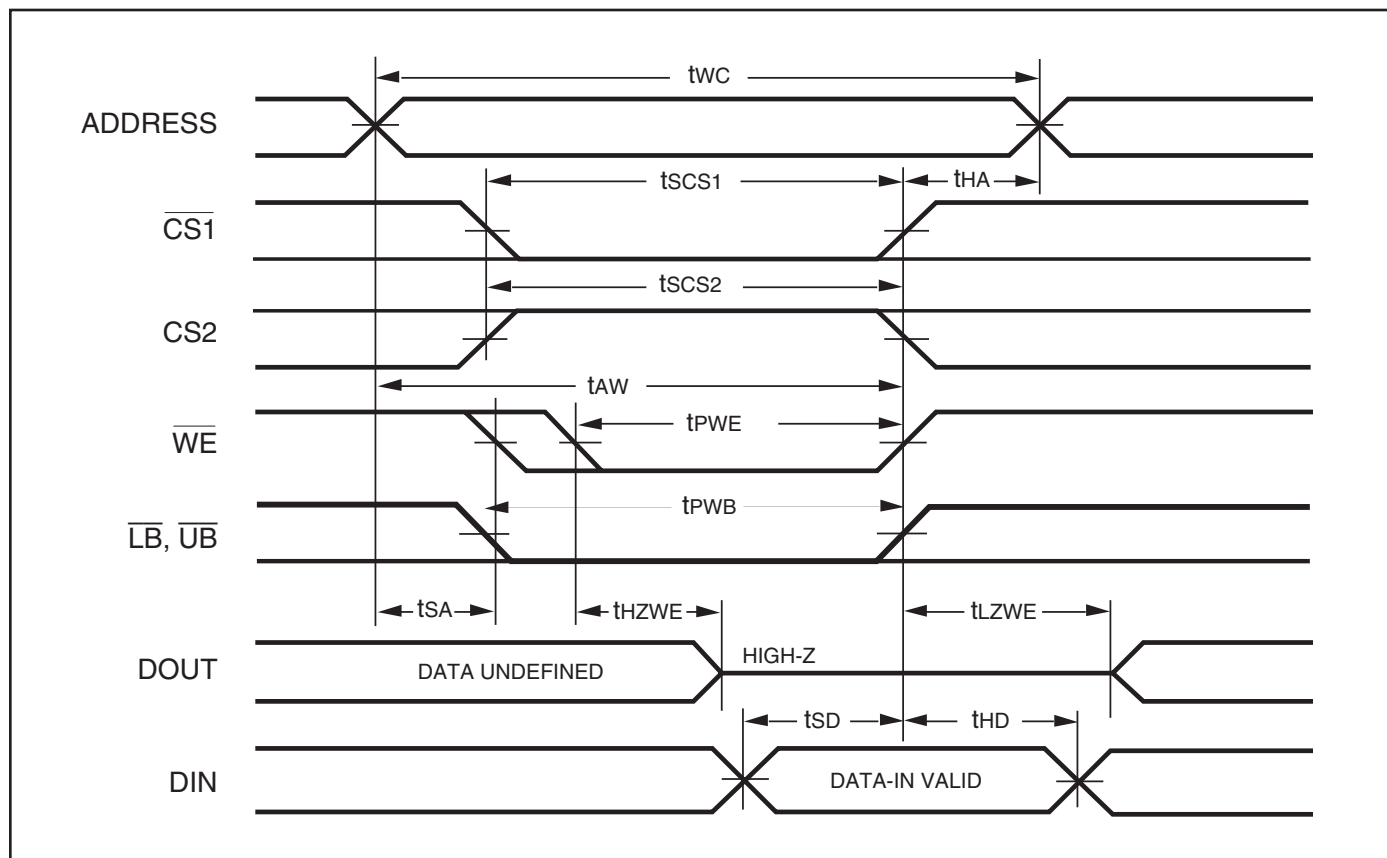
**WRITE CYCLE SWITCHING CHARACTERISTICS<sup>(1,2)</sup>** (Over Operating Range)

| Symbol                               | Parameter                                                             | 45ns |      | 55 ns |      | 70 ns |      | Unit |
|--------------------------------------|-----------------------------------------------------------------------|------|------|-------|------|-------|------|------|
|                                      |                                                                       | Min. | Max. | Min.  | Max. | Min.  | Max. |      |
| t <sub>WC</sub>                      | Write Cycle Time                                                      | 45   | —    | 55    | —    | 70    | —    | ns   |
| t <sub>SCS1</sub> /t <sub>SCS2</sub> | $\overline{\text{CS1}}$ /CS2 to Write End                             | 35   | —    | 45    | —    | 60    | —    | ns   |
| t <sub>AW</sub>                      | Address Setup Time to Write End                                       | 35   | —    | 45    | —    | 60    | —    | ns   |
| t <sub>HA</sub>                      | Address Hold from Write End                                           | 0    | —    | 0     | —    | 0     | —    | ns   |
| t <sub>SA</sub>                      | Address Setup Time                                                    | 0    | —    | 0     | —    | 0     | —    | ns   |
| t <sub>PWB</sub>                     | $\overline{\text{LB}}$ , $\overline{\text{UB}}$ Valid to End of Write | 35   | —    | 45    | —    | 60    | —    | ns   |
| t <sub>PWE</sub>                     | $\overline{\text{WE}}$ Pulse Width                                    | 35   | —    | 40    | —    | 50    | —    | ns   |
| t <sub>SD</sub>                      | Data Setup to Write End                                               | 20   | —    | 25    | —    | 30    | —    | ns   |
| t <sub>HD</sub>                      | Data Hold from Write End                                              | 0    | —    | 0     | —    | 0     | —    | ns   |
| t <sub>HZWE</sub> <sup>(3)</sup>     | $\overline{\text{WE}}$ LOW to High-Z Output                           | —    | 20   | —     | 20   | —     | 20   | ns   |
| t <sub>LZWE</sub> <sup>(3)</sup>     | $\overline{\text{WE}}$ HIGH to Low-Z Output                           | 5    | —    | 5     | —    | 5     | —    | ns   |

**Notes:**

1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 0.9V, input pulse levels of 0.4V to 1.4V and output loading specified in Figure 1.
2. The internal write time is defined by the overlap of  $\overline{\text{CS1}}$  LOW, CS2 HIGH and  $\overline{\text{UB}}$  or  $\overline{\text{LB}}$ , and  $\overline{\text{WE}}$  LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.
3. Tested with the load in Figure 2. Transition is measured  $\pm 500$  mV from steady-state voltage. Not 100% tested.

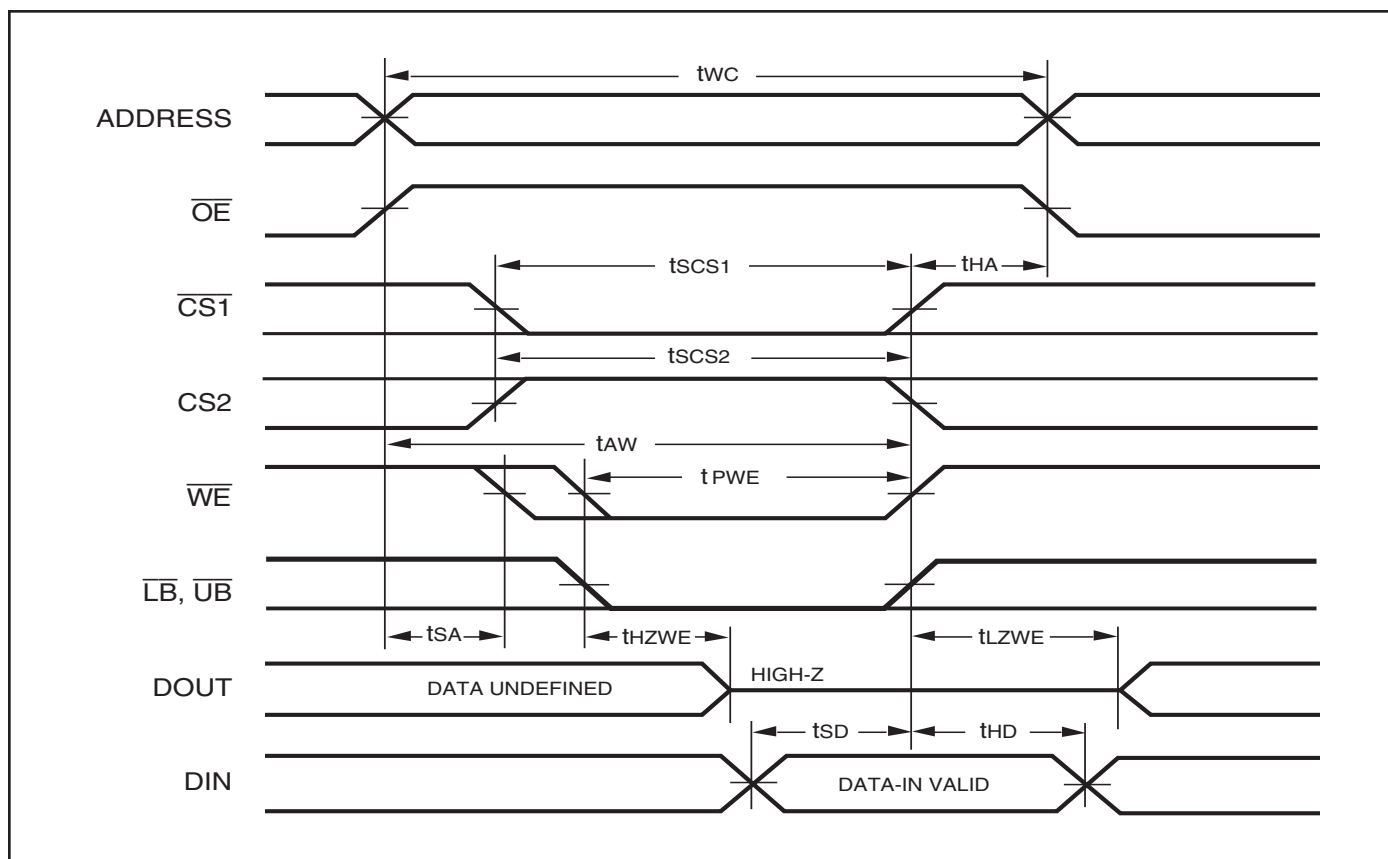
## AC WAVEFORMS

WRITE CYCLE NO. 1<sup>(1,2)</sup> ( $\overline{CS1}$  Controlled,  $\overline{OE}$  = HIGH or LOW)

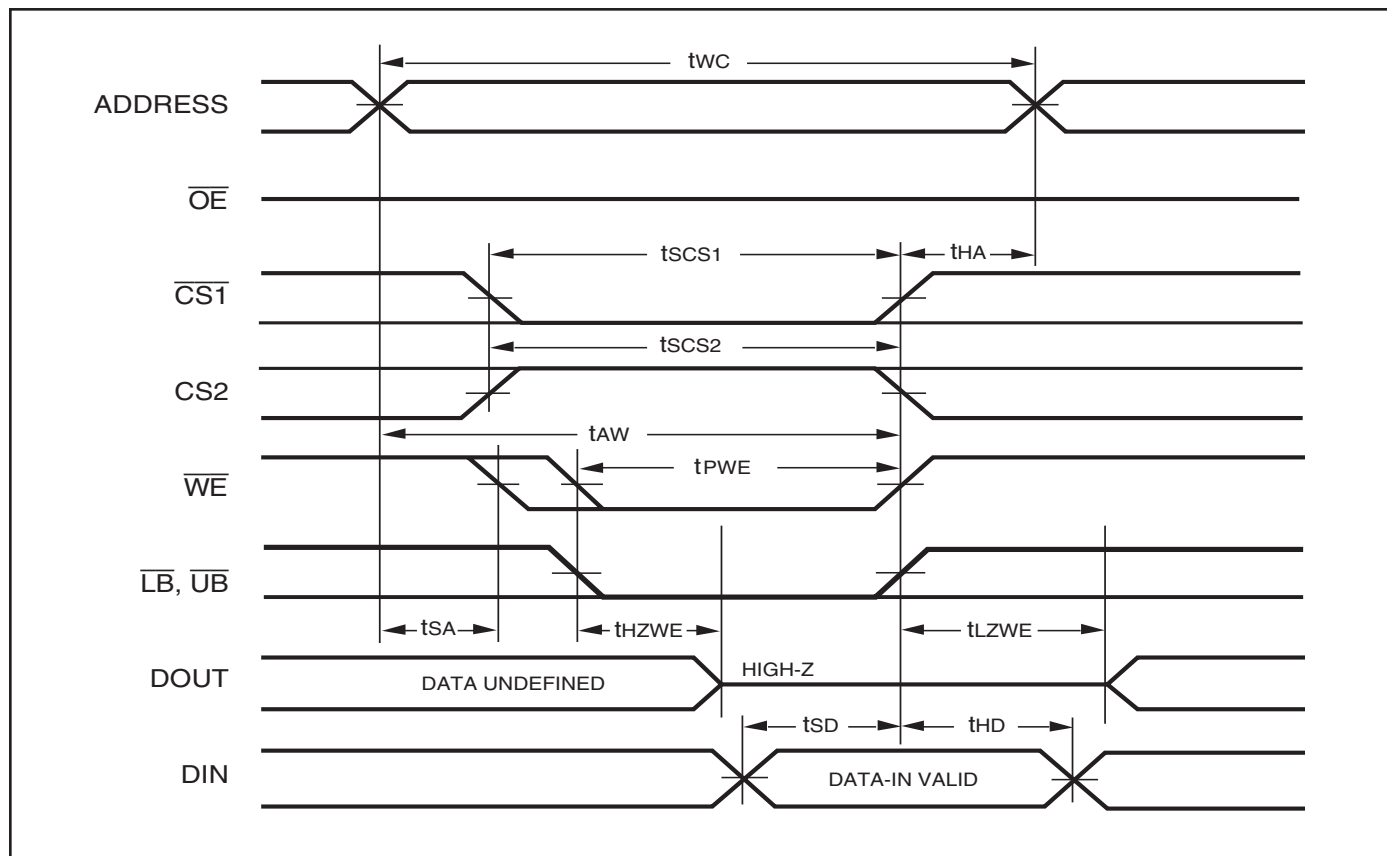
## Notes:

1. WRITE is an internally generated signal asserted during an overlap of the LOW states on the  $\overline{CS1}$ ,  $\overline{CS2}$  and  $\overline{WE}$  inputs and at least one of the  $\overline{LB}$  and  $\overline{UB}$  inputs being in the LOW state.
2.  $WRITE = (\overline{CS1}) [(\overline{LB}) = (\overline{UB})] (\overline{WE})$ .

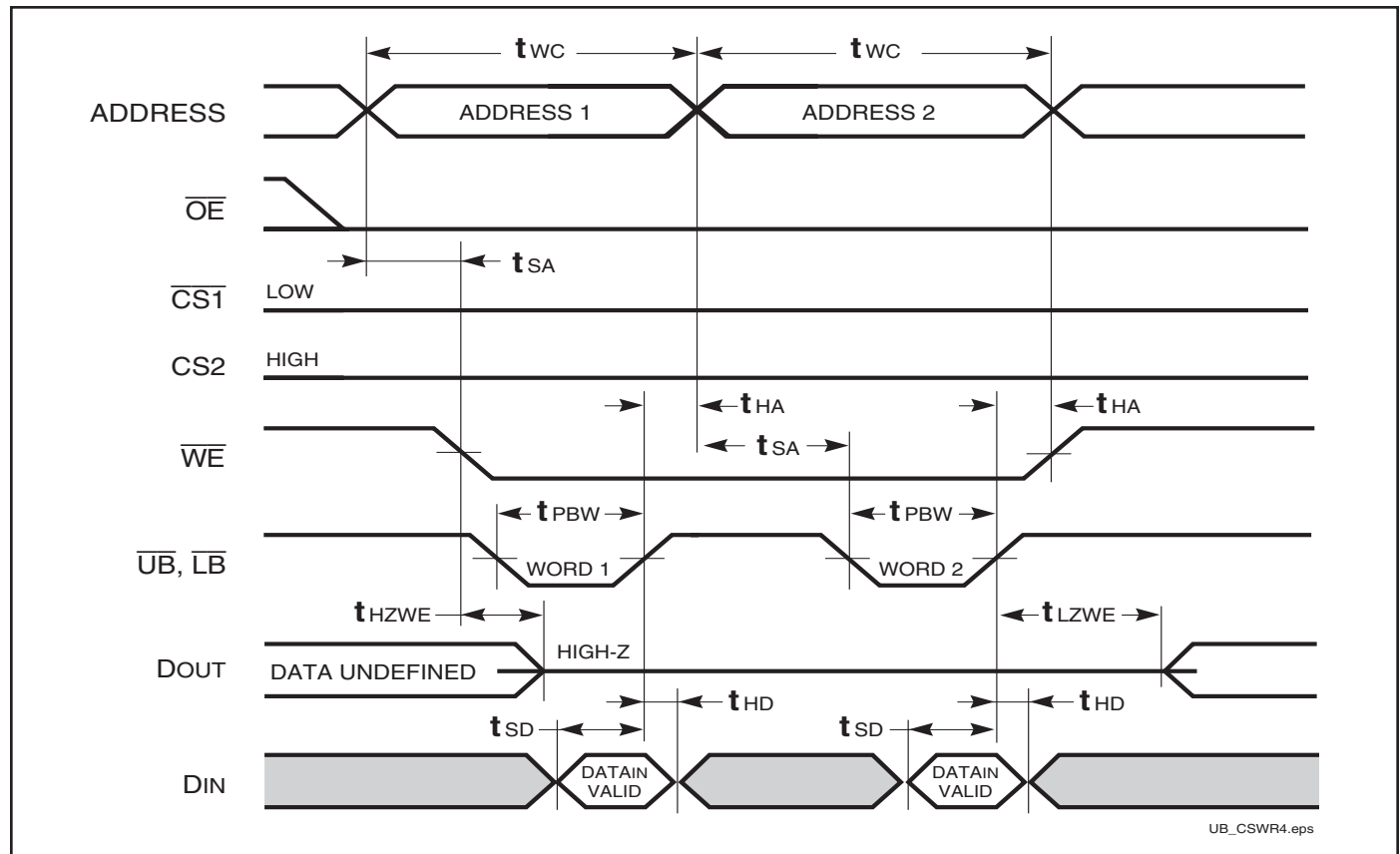
## AC WAVEFORMS

WRITE CYCLE NO. 2 ( $\overline{WE}$  Controlled:  $\overline{OE}$  is HIGH During Write Cycle)

## AC WAVEFORMS

WRITE CYCLE NO. 3 ( $\overline{WE}$  Controlled:  $\overline{OE}$  is LOW During Write Cycle)

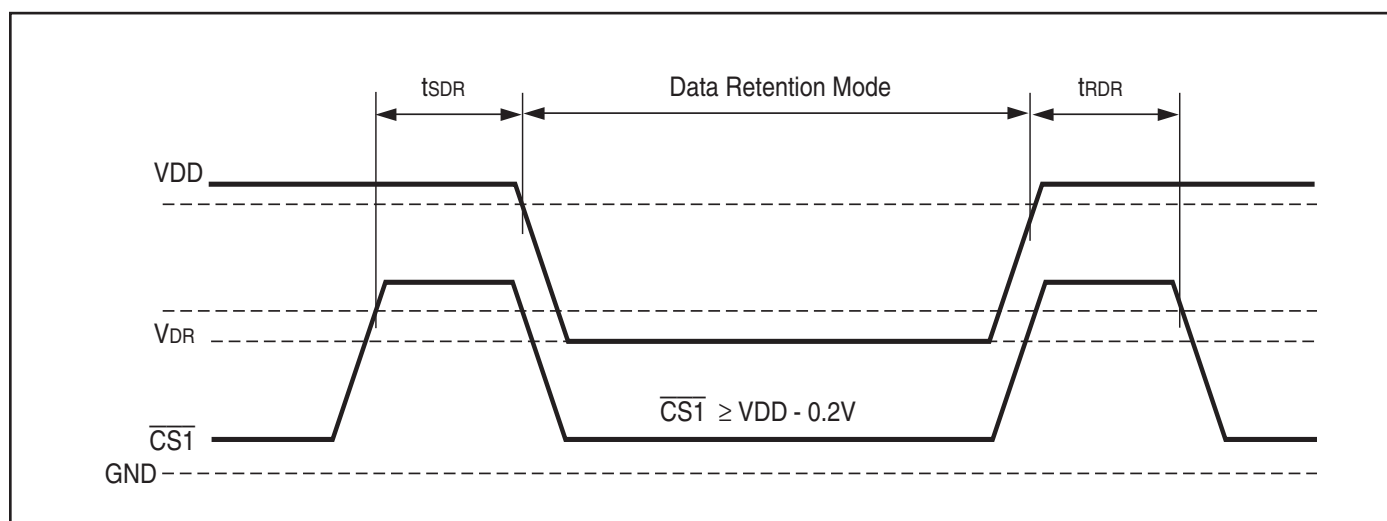
## AC WAVEFORMS

WRITE CYCLE NO. 4 ( $\overline{UB}/\overline{LB}$  Controlled)

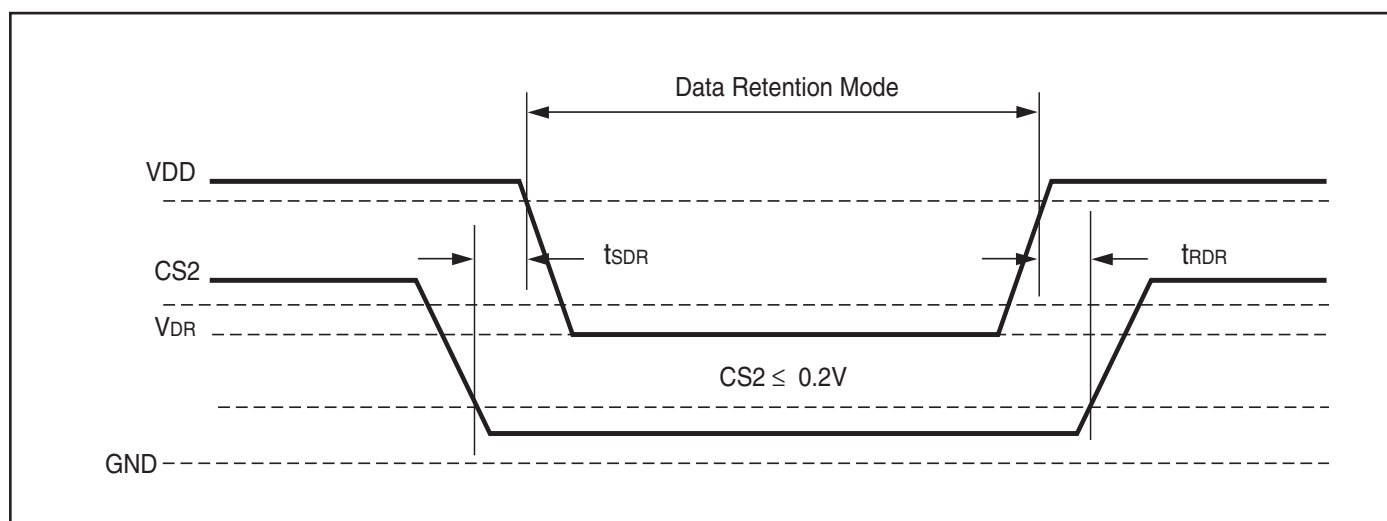
## DATA RETENTION SWITCHING CHARACTERISTICS

| Symbol    | Parameter                   | Test Condition                                        | Min.     | Max. | Unit    |
|-----------|-----------------------------|-------------------------------------------------------|----------|------|---------|
| $V_{DR}$  | $V_{DD}$ for Data Retention | See Data Retention Waveform                           | 1.0      | 3.6  | V       |
| $I_{DR}$  | Data Retention Current      | $V_{DD} = 1.0V$ , $\overline{CS1} \geq V_{DD} - 0.2V$ | —        | 10   | $\mu A$ |
| $t_{SDR}$ | Data Retention Setup Time   | See Data Retention Waveform                           | 0        | —    | ns      |
| $t_{RDR}$ | Recovery Time               | See Data Retention Waveform                           | $t_{RC}$ | —    | ns      |

### DATA RETENTION WAVEFORM ( $\overline{CS1}$ Controlled)



### DATA RETENTION WAVEFORM ( $CS2$ Controlled)



## IS62WV12816ALL, IS62WV12816BLL

### ORDERING INFORMATION: IS62WV12816ALL (1.65V - 2.2V)

#### Commercial Range: 0°C to +70°C

| Speed (ns) | Order Part No.     | Package        |
|------------|--------------------|----------------|
| 70         | IS62WV12816ALL-70T | TSOP (Type II) |

#### Industrial Range: -40°C to +85°C

| Speed (ns) | Order Part No.       | Package                           |
|------------|----------------------|-----------------------------------|
| 70         | IS62WV12816ALL-70TI  | TSOP (Type II)                    |
| 70         | IS62WV12816ALL-70BI  | mini BGA (6mm x 8mm)              |
| 70         | IS62WV12816ALL-70BLI | mini BGA (6mm x 8mm), Lead-free   |
| 70         | IS62WV12816ALL-70B2I | mini BGA (6mm x 8mm), 2 CS Option |

### ORDERING INFORMATION: IS62WV12816BLL (2.5V - 3.6V)

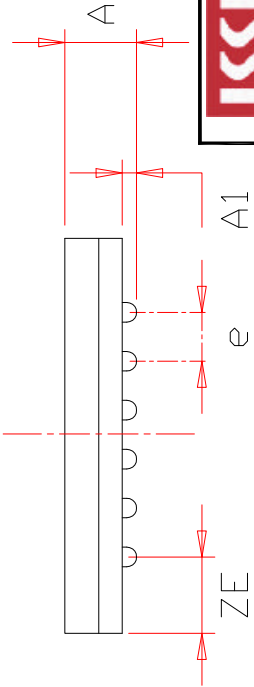
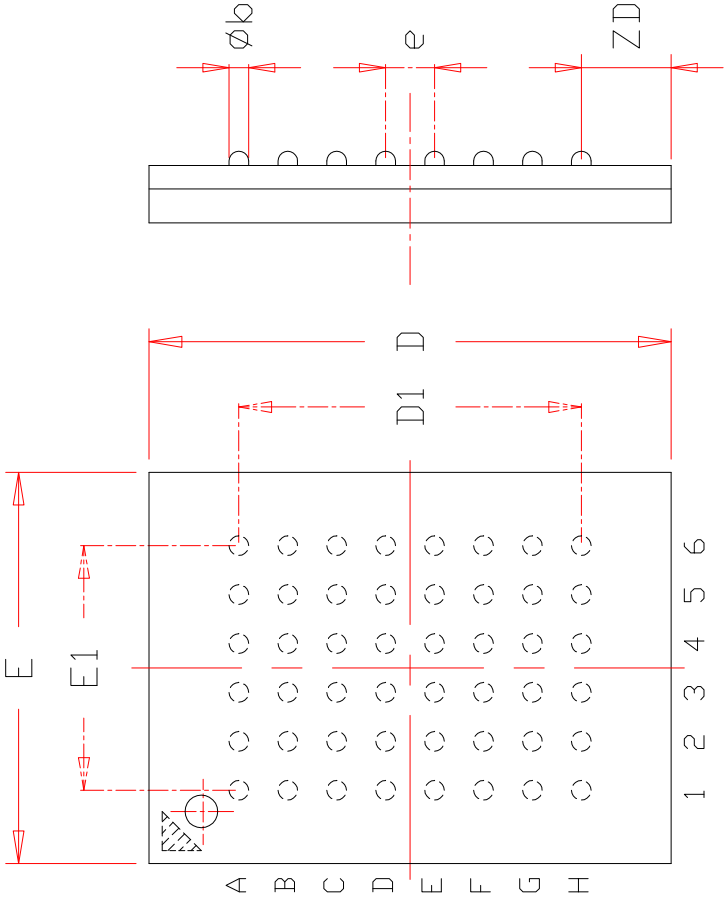
#### Commercial Range: 0°C to +70°C

| Speed (ns) | Order Part No.      | Package                           |
|------------|---------------------|-----------------------------------|
| 45         | IS62WV12816BLL-45B  | mini BGA (6mm x 8mm)              |
| 45         | IS62WV12816BLL-45B2 | mini BGA (6mm x 8mm), 2 CS Option |
| 55         | IS62WV12816BLL-55T  | TSOP (Type II)                    |

#### Industrial Range: -40°C to +85°C

| Speed (ns) | Order Part No.        | Package                                      |
|------------|-----------------------|----------------------------------------------|
| 45         | IS62WV12816BLL-45TLI  | TSOP (Type II), Lead-free                    |
| 45         | IS62WV12816BLL-45BLI  | mini BGA (6mm x 8mm), Lead-free              |
| 55         | IS62WV12816BLL-55TI   | TSOP (Type II)                               |
| 55         | IS62WV12816BLL-55TLI  | TSOP (Type II), Lead-free                    |
| 55         | IS62WV12816BLL-55BI   | mini BGA (6mm x 8mm)                         |
| 55         | IS62WV12816BLL-55BLI  | mini BGA (6mm x 8mm), Lead-free              |
| 55         | IS62WV12816BLL-55B2I  | mini BGA (6mm x 8mm), 2 CS Option            |
| 55         | IS62WV12816BLL-55B2LI | mini BGA (6mm x 8mm), 2 CS Option, Lead-free |

TOP VIEW



| SYMBOL | DIMENSION IN MM |      |      | DIMENSION IN INCH |       |       |
|--------|-----------------|------|------|-------------------|-------|-------|
|        | MIN.            | NOM. | MAX. | MIN.              | NOM.  | MAX.  |
| A      |                 |      | 1.20 |                   |       | 0.047 |
| A1     | 0.20            |      | 0.30 | 0.008             |       | 0.012 |
| øb     | 0.30            | 0.35 | 0.40 | 0.012             | 0.014 | 0.016 |
| D      | 7.90            | 8.00 | 8.10 | 0.311             | 0.315 | 0.319 |
| D1     | 5.25 BSC        |      |      | 0.207 BSC         |       |       |
| E      | 5.90            | 6.00 | 6.10 | 0.232             | 0.236 | 0.240 |
| E1     | 3.75 BSC        |      |      | 0.148 BSC         |       |       |
| e      | 0.75 BSC.       |      |      | 0.030 BSC.        |       |       |
| ZD     | 1.375 REF.      |      |      | 0.054 REF.        |       |       |
| ZE     | 1.125 REF.      |      |      | 0.044 REF.        |       |       |

NOTE :

- 1. CONTROLLING DIMENSION : MM .
- 2. Reference document : JEDEC MO-207



TITLE

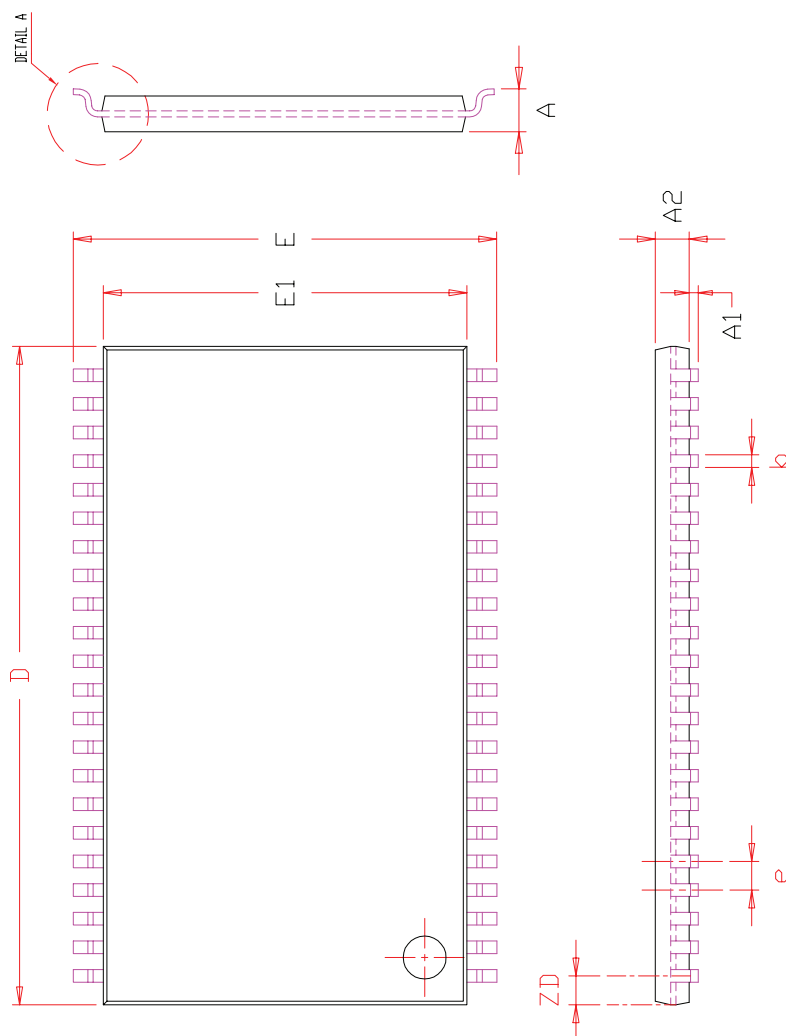
48L 6x8mm TF-BGA  
Package Outline

REV.

C

DATE

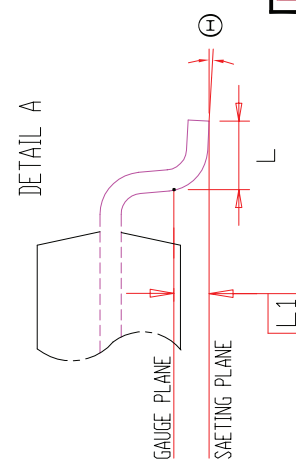
08/12/2008



| SYMBOL | DIMENSION IN MM |       |       | DIMENSION IN INCH |       |       |
|--------|-----------------|-------|-------|-------------------|-------|-------|
|        | MIN.            | NOM.  | MAX.  | MIN.              | NOM.  | MAX.  |
| A      | 1.00            |       | 1.20  | 0.039             |       | 0.047 |
| A1     | 0.05            |       | 0.15  | 0.002             |       | 0.006 |
| A2     | 0.95            | 1.00  | 1.05  | 0.037             | 0.039 | 0.041 |
| b      | 0.30            |       | 0.45  | 0.012             |       | 0.018 |
| D      | 18.28           | 18.41 | 18.54 | 0.720             | 0.725 | 0.730 |
| E      | 11.56           | 11.76 | 11.96 | 0.455             | 0.463 | 0.471 |
| E1     | 10.03           | 10.16 | 10.29 | 0.395             | 0.400 | 0.405 |
| e      | 0.80 BSC.       |       |       | 0.031 BSC.        |       |       |
| L      | 0.40            |       | 0.69  | 0.016             |       | 0.027 |
| L1     | 0.25 BSC.       |       |       | 0.010 BSC.        |       |       |
| ZD     | 0.805 REF.      |       |       | 0.032 REF.        |       |       |
| Θ      | 0               |       | 8°    | 0                 |       | 8°    |

**NOTE :**

1. CONTROLLING DIMENSION : MM
2. DIMENSION D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION.

**TITLE**
**44L 400mil TSOP-2**  
 Package Outline
**REV.****F****DATE**

06/04/2008